

markings to show changes made.” In addition, Korean counsel has kindly provided a substitute specification which does not add any new matter but has easier to understand grammar. A marked up and clean copy are provided.

Claim Rejections – 35 USC § 102

Each of the claims were rejected as being anticipated by Akram et al., U.S. Patent 6,155,247. The Examiner noted that the claims were objectionable, as they were “best understood” due to the translation difficulties. As amended to conform to US practice, the claims are clearly neither anticipated by nor made obvious by Akram et al.

Akram et al. is directed to a method for sawing semiconductor wafers. The patent shows very little of interest, with a wafer saw blade 18 being mentioned as having diamond or a toothed blade. No reference is made as to where the diamond may be placed on the saw blade.

The claims in this application present a diamond saw blade in which there are at least two separate and spaced diamond layers, spaced by a region of either no diamond particles or a lesser density of diamond particles. The benefits of the invention flow by the creation of multiple groove cutting regions caused by the spacing of diamond and non-diamond layers which effectively breaks off larger chunks by grinding spaced grooves, which are then easily snapped off by the action of the blade.

The feature of the diamond blade having a rim type cutting tip according to the present invention is to easily and quickly grind or cut workpieces by forming one or more cutting grooves in the workpieces and discharging relatively large size chips from the cutting slots including the cutting grooves. Here, the chips are generated according the projections left between the cutting grooves which are cut off by a small friction and rotation impact force of the rim type cutting tip (or non-diamond portions).

In order to accomplish the objects, as shown in Figures 4 and 5, the diamond blades according to the present invention comprises, a wheel body 32 connected with a shaft of an electric motor and a rim type cutting tip 33 circumferentially and fixedly onto the wheel body 32. Here, the rim type cutting tip 33 comprises the diamond layers 38 and 38' including a plurality of

embodiment of Figure 4.

Meanwhile, the feature of the apparatus and method for sawing semiconductor wafers according to Akram et al. is to saw differently-dimensioned dices on a single semiconductor wafer with a wafer saw with a wafer saw blade or two laterally-spaced blades.

In Akram et al., the wafer saw 10 with a single wafer saw blade, as shown in Figures 1 and 2, comprises a base 12 supporting a semiconductor wafer 24; a support 16 extended from the base 12; a first extension arm 14 supported by the support 16; a second extension arm 15 suspended by the first extension arm 14; a wafer saw blade 18 attached to a spindle or a hub 20 which is rotatably attached to the extension arm 15.

Also, the Akram et al. wafer saw 30 with the two laterally-spaced blades 32 and 34, as shown in Figures 3, is constructed like the wafer saw of Figure 1 or 2 except for the saw blades 32 and 34 and extension arms attaching the saw blades 32 and 34. The extension arm 34 of Akram et al. is horizontally movable to cut the wafer in various sizes as shown in Figure 3.

Further, the Akram et al. wafer saw 70 with the two saw blades 72 and 74, as shown in Figure 6, is constructed like that of Figure 3 except for the structure of the extension arm 74. Namely, the extension arm 74 is vertically movable to cut and/or form a desired street on the wafer.

The diamond blade according to the present invention comprises a rim type cutting tip with two or more diamond layers and non-diamond portion between them. Especially, as mentioned above, the diamond layer shaped as a rectangular wave form with respect to the cutting surface of the workpiece as the diamond layers have a plurality of depressed portions formed on the side surface of the rim with a predetermined depth from the surface of the rim.

When the diamond blade of the present invention rotates to cut or grind workpieces, it forms one or more microscopic liner cutting grooves in the workpiece and then cuts or grinds it.

The wafer blades of Akram never disclose a diamond layer and non-diamond portion in the rim type cutting tip. Also, the wafer blades never form one or more microscopic liner cutting grooves in a cutting slot of the wafer when cutting the wafer.

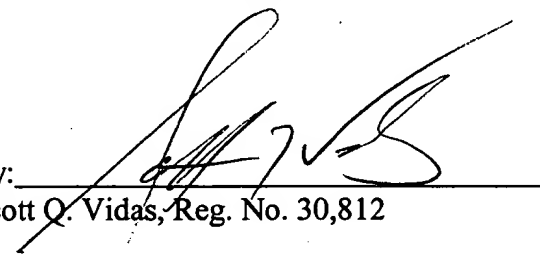
Nothing in the Akram et al. reference provides any suggestion, let alone a

CONCLUSION

In view of the foregoing it is believed that the present application, with claims 1-16 is in condition for allowance. Early action to that effect is earnestly solicited.

Respectfully submitted,
VIDAS, ARRETT & STEINKRAUS, P.A.

Date: August 27, 2002

By: 
Scott Q. Vidas, Reg. No. 30,812

Enc: Subst. Spec, Extension fee

Suite 2000
6109 Blue Circle Drive
Minnetonka, Minnesota 55343-9185
Telephone No: (952) 563-3000
Facsimile No: (952) 563-3001
E-Mail: svidas@vaslaw.com

VERSION WITH MARKINGS TO SHOW CHANGES MADE

In the Claims:

Please amend the claims as follows:

1. (Amended) A diamond blade [having rim type cutting tip] for [use in] grinding or cutting workpieces, the diamond blade [apparatus] comprising: [:]

a wheel body having a radius about which said wheel body rotates and a periphery, said periphery defined by both outer surfaces of said wheel body and a peripheral edge therebetween; and [connected with a shaft of electric motor, and said]

a rim type cutting tip for cutting or grinding [crushable materials] workpieces, the rim type cutting tip being fixed to the circumference of said wheel body, said rim type cutting tip including:

[disposed on the circumference of said wheel body and composed of] at least two diamond layers longitudinally disposed parallel with the rotation direction of the wheel body, the diamond layers including [blade in which] a plurality of diamond particles; [are included,] and

a non-diamond portion disposed between the diamond layers in which diamond particles are not included.

2. (Amended) [A] The diamond blade as claimed in claim 1, wherein said diamond layers are each other disposed at predetermined intervals perpendicular [with] to the rotation direction of the diamond blade between the non-diamond portions of said rim type cutting tip.

3. (Amended) [A] The diamond blade as claimed in claim 1, wherein said diamond layers are [only] on [inner and] both outer [surface] surfaces of the rim type cutting tip and not said periphery edge.

4. (Amended) [A] The diamond blade as claimed in claim 1, wherein the plurality of

diamond particles in each diamond layer of the rim type cutting tip are distributed in a [given] predetermined pattern or arrangement.

5. (Amended) [A] The diamond blade as claimed in claim 4, wherein said diamond particles in each diamond layer of the rim type cutting tip are distributed in a single layer [figure] with grid shaped spots.

6. (Amended) [A] The diamond blade as claimed in claim 4, wherein said diamond particles in each diamond layer of the rim type cutting tip are distributed in a double layer [figure] with grid shaped spots.

7. (Amended) [A] The diamond blade as claimed in claim 1, wherein said diamond particles in each diamond layer of the rim type cutting tip are randomly distributed.

Please delete claim 8.

9. (Amended) A diamond blade [having rim type cutting tip for use in] for cutting or grinding workpieces, the diamond blade [apparatus] comprising[:];

a wheel body having a radius about which said wheel body rotates and a periphery, said periphery defined by both outer surfaces of said wheel body and a peripheral edge therebetween; [connected with a shaft of electric motor,] and [said]

a rim type cutting tip for cutting or grinding [crushable materials] said workpieces, the rim type cutting tip circumferentially and fixedly disposed on [the circumference of] said wheel body said wheel body including:

[and composed of] a non-diamond portion having a plurality of depressed portions, the depressed portions being disposed at predetermined intervals to cross each other [in] on both [inner and] outer surfaces of the non-diamond portion;[, and

a plurality of diamond layers longitudinally disposed parallel with the rotation direction

of the diamond blade respectively on depressed bottom surfaces of the depressed portions, [of non-diamond portion] and on both [inner and] outer surfaces of the non-diamond portion divided by the depressed portions [thereof] of the non-diamond portion, wherein the depressed bottom surfaces and both outer surfaces are parallel to the rotation direction of the diamond blade.

10. (Amended) [A] The diamond blade as claimed in claim 9, wherein [all] the bottom surfaces of the depressed portions of the non-diamond portion are positioned in [the] a plane [forming the center] between both [inner and] outer surfaces of the non-diamond portion [to let diamond layers disposed thereon to form one cutting line during the cutting operation of blade].

11. (Amended) [A] The diamond blade as claimed in claim 9, wherein the depth of [all] the depressed bottom surfaces of the depressed portions of both outer [of inner and outer] surfaces of the non-diamond portion is [set up to be] less than a half of the [entire] thickness of the non-diamond portion [to let diamond layers disposed thereon to form two linear cutting line during the cutting operation of blade].

12. (Amended) [A] The diamond blade as claimed in claim 9, wherein the diamond particles in each diamond layer of the rim type cutting tip are distributed in a [given] predetermined pattern or arrangement.

13. (Amended) [A] The diamond blade as claimed in claim 12, wherein the diamond particles in each diamond layer of the rim type cutting tip are distributed in a single layer [figure] with grid shaped spots.

14. (Amended) [A] The diamond blade as claimed in claim 12, wherein the diamond particles in each diamond layer of the rim type cutting tip are distributed in a double

layer [figure] with grid shaped spots.

15. (Amended) [A] The diamond blade as claimed in claim 9, wherein the diamond particles in each diamond layer of the rim type cutting tip are randomly distributed.

Please delete claim 16.

Please add the following new claims:

17. A diamond blade for grinding or cutting workpieces, the diamond blade comprising:

a wheel body having a radius about which said wheel body rotates and a periphery, said periphery defined by both outer surfaces of said wheel body and a peripheral edge therebetween; and

a rim type cutting tip for cutting or grinding workpieces, the rim type cutting tip being fixed to the circumference of said wheel body, said rim type cutting tip including:

a plurality of spaced diamond layers longitudinally disposed parallel with the rotation direction of the wheel body, each of the diamond layers including a plurality of diamond particles; and

a non-diamond portion disposed between each of the diamond layers in which a relatively lower density of diamond particles are included.

18. A diamond blade for grinding or cutting workpieces, the diamond blade comprising:

a wheel body having a radius about which said wheel body rotates and a periphery, said periphery defined by both outer surfaces of said wheel body and a peripheral edge therebetween, said both outer surfaces including a plurality of spaced depressions adjacent said peripheral edge; and

a rim type cutting tip for cutting or grinding workpieces, the rim type cutting tip being fixed to the circumference of said wheel body, said rim type cutting tip including:

a plurality of spaced diamond layers on both outer surfaces, longitudinally disposed parallel with the rotation direction of the wheel body, each of the diamond layers including a plurality of diamond particles, said diamond layers being disposed in the spaced depressions; and

a non-diamond portion disposed between each of the diamond layers in which a relatively lower density of diamond particles are included.

DIAMOND BLADE HAVING RIM TYPE CUTTING TIP FOR GRINDING OR CUTTING
WORKPIECES

Deleted: USE IN

Deleted: APPARATUS

BACKGROUND OF THE INVENTION

5

The present invention relates to a diamond blade for an apparatus such as a cutting saw machine for grinding or cutting workpieces such as brick, concrete, granite, marble, etc., and more particularly to a diamond blade having a rim type cutting tip in which at least two diamond layers are longitudinally disposed along the rotation direction of the diamond blade to form microscopic linear cutting grooves to cause portions of the workpieces between the cutting grooves to be crushed in chips of relatively large size by non-diamond portion of the rim type cutting tip during the cutting operation, and thereby to enhance cutting rate of the diamond blade and to prevent the crushed chips from dispersing easily in the air and from causing bad affects to user's health and the contamination of environment.

Deleted: use in

Deleted: crushable materials

10

Deleted: crushable materials

15

FIG.1 is a front view of one conventional diamond blade for a cutting saw machine for grinding or cutting workpieces in which diamond particles are randomly distributed on a rim type cutting tip thereof, the conventional diamond blade 1 comprises a steel wheel body 2 whose center hole is connected with a shaft of electric motor, and a rim type cutting tip 3 disposed circumferentially and fixedly on the steel wheel body 2. Here, the rim type cutting tip 3 is fabricated by mixing abrasive materials such as diamond and metal powders composing of cobalt, nickel, bronze, copper, etc., or particles of resin or ceramic, and then forming a rim of predetermined shape from the mixed particles.

Deleted: ability

Deleted: giving rise to

Deleted: the

Deleted: effects

Deleted: A

Deleted: for use in apparatus for cutting crushable materials such as cutting saw machine

Deleted: , as shown in FIG. 1. Rim

Deleted: particles of diamond and grinding materials

Deleted: , particles of metals

Deleted: and

Deleted: given

Deleted: out of

Deleted: by plastic working including press work

Deleted: Thus

20

Especially, the diamond particles 4 are randomly distributed in the inside and on the surfaces of the rim type cutting tip 3 as shown in FIG. 3.

In the diamond blade 1, as shown in FIG. 3, both outer surfaces of the rim type cutting tip 3 contacts with corresponding surface portion of workpiece 18, and grinds it to form a cutting slot 16 in workpiece 18 during the cutting operation.

Deleted: upper surface...crushable materials...to be cut...crushable materials...as shown in FIG.3

[1]

Minute chips produced during the cutting operation of the rim type cutting tip 3 are gathered in the cutting slot 16 and then discharged from there outside by the rotation of the rim type cutting tip 3.

Deleted: by...to

[2]

However, since both surfaces of the rim type cutting tip 3 of the diamond blade 1 has the same shape and the same material composition on the whole, both edges 15 of the rim type cutting tip 3 contacting with the side walls and bottom of the cutting slot 16 are defaced faster than the center 17 of the rim type cutting tip 3 contacting only with the bottom of the cutting slot 16.

Deleted: the blade 1, i.e., upper surface...upper surface...wall...formed in crushable materials 18 during cutting operation...thereof...of crushable materials

[3]

Accordingly, the contacting area between the upper surface of the rim type cutting tip 3 and the workpiece 18 is enlarged to increase resistance of the workpieces 18, and thereby causing poor cutting and decreasing cutting rate and the life of the diamond blade 1.

Deleted: crushable materials...to be cut...crushable materials...be able to induce...decrease...ability

[4]

Further, since the size of chips produced during the cutting operation is are relatively very minute, these chips remains in the cutting slot 16 and prevents the upper surface of the rim type cutting tip 3 from grinding the bottom of the cutting slot 16, and thereby decreasing cutting rate. Also, if those minute chips discharged from the cutting slot 16 are dispersed in the air, it causes the bad affects to user's health and the contamination of environment.

Deleted: size...are easy to remain...of crushable materials 18 to...prevent...decrease...ability...in case of...gave rise to...effects

[5]

To improve these problems, there has been proposed a diamond blade 11, as shown in FIG. 2.

Deleted: problem

FIG.2 is a front view of the other conventional diamond blade in which diamond particles are randomly distributed in rim type cutting tip thereof and a plurality of depressed portions are disposed in both outer surfaces of the rim type cutting tip thereof. Namely, the conventional diamond blade 11 has a plurality of depressed portions 19 formed with a

Deleted: that...are at given intervals

[6]

predetermined interval in both surfaces of a rim type cutting tip 13. Here, the rim type cutting tip 13 is disposed circumferentially and fixedly on a steel wheel body 12 and has a plurality of diamond particles 14 on its surfaces.

However, even though the diamond blade 11 is improved tip to be defaced during the cutting operation as the minute chips are effectively discharged from the cutting slot, it has still the disadvantages to deface both edges of upper surface to induce poor cutting, to decrease its own cutting rate and life of blade, to produce very minute chips to decrease its own cutting rate, and to disperse the produced minute chips in the air, which cause the bad affects to user's health and the contamination of environment.

SUMMARY OF THE INVENTION

It is a main object of the present invention to provide a diamond blade for cutting or grinding workpieces such as brick, concrete, granite, marble, etc., having a rim type cutting tip in which at least two diamond layers are longitudinally disposed along the rotation direction of the diamond blade to form microscopic cutting grooves in the workpieces during the cutting operation, and thereby to cause portion of workpieces between the microscopic cutting grooves to be easily crushed by non-diamond portion of the rim type cutting tip to enhance cutting rate of the diamond blade.

It is another object of the present invention to provide a diamond blade for an apparatus such as cutting saw machine having a structure which a rim type cutting tip is able to produce cutting chips of a relatively large size during the cutting operation so that those chips are easily discharged from the cutting slots outside with reducing the friction with the rim type cutting tip of the diamond blade, thereby to increase cutting rate and to prevent those chips from dispersing in

Deleted:	inner and outer
Deleted:	, as shown in FIG.2
Deleted:	By virtue of this blade, discharging of minute chips remaining in cutting slot of crushable materials causing rim type cutting
Deleted:	has been improved, but
Deleted:	defacement of
Deleted:	and
Deleted:	ability
Deleted:	producing
Deleted:	ability
Deleted:	dispersing
Deleted:	to give rise to
Deleted:	effects
Deleted:	are still remained in problems ... [7]
Deleted:	an
Deleted:	for use in apparatus such as ... [8]
Deleted:	crushable materials
Deleted:	
Deleted:	crushable materials
Deleted:	crushable materials
Deleted:	ability
Deleted:	use in
Deleted:	
Deleted:	with
Deleted:	relative
Deleted:	
Deleted:	
Deleted:	ability

the air and rise to from causing a bad affects, to user's health and the contamination of environment.

Deleted: giving

Deleted: the

Deleted: effects

It is the other object of the present invention to provide a diamond blade for use in an apparatus such as a cutting saw machine having a rim type cutting tip which diamond particles in
5 diamond layer thereof are distributed in a given pattern to reduce the amount of diamond particles used and thereby reducing the manufacturing cost of the diamond blade.

Deleted:

Deleted:

Deleted: reduce

To accomplish these objects, a diamond blade for grinding or cutting workpieces according to the present invention comprises a wheel body connected with a shaft of an electric motor, and a rim type cutting tip for grinding or cutting workpieces disposed on the
10 circumference of the wheel body, and composed of at least two diamond layers longitudinally disposed parallel with the rotation direction of the diamond blade in which diamond particles are included, and a non-diamond portion disposed between the diamond layers in which the diamond particles are not included.

Deleted: use in apparatus for

Deleted: crushable materials

Deleted: crushable materials

In this embodiment of the present invention, the diamond layers are disposed each other
15 at predetermined intervals perpendicular to the rotation direction of the diamond blade.

Deleted: with

It is desirable that the diamond layers are disposed only on both surfaces of the rim type cutting tip.

Deleted: inner and outer surface

Alternatively, the diamond particles in each diamond layer of the rim type cutting tip are distributed in a predetermined pattern or arrangement such a single or double layer figure with
20 grid shaped spots.

Deleted: given

Also, in the non-diamond portion of the rim type cutting tip, the diamond particles can be distributed in the density lower than that of the diamond layers.

In the other embodiment of the present invention, a diamond blade for for grinding or cutting workpieces comprises a wheel body connected with a shaft of an electric motor, and a
25 rim type cutting tip for grinding or cutting workpieces, which is disposed on the circumference

Deleted: use in apparatus

Deleted: crushable materials

Deleted: crushable materials

of the wheel body and composed of a non-diamond portion having a plurality of depressed portions disposed at predetermined intervals to cross each other in both surfaces of the non-diamond portion, and a plurality of diamond layers longitudinally disposed parallel with the rotation direction of the diamond blade respectively on bottom surfaces of the depressed portions of the non-diamond portion and both surfaces of the non-diamond portion divided by depressed portions thereof.

Deleted: inner and outer

Deleted: inner and outer

In this embodiment of the present invention, it is desirable that the bottom surfaces of the depressed portions of the non-diamond portion are positioned in the plane forming the center between both surfaces of non-diamond portion to let the diamond layers disposed thereon to form one cutting line during the cutting operation of the diamond blade.

Deleted: inner and outer

Also, a depth of all bottom surfaces of the depressed portions of both surfaces of the non-diamond portion can be set up to be less than a half of the thickness of the non-diamond portion to let the diamond layers disposed thereon to form at least two linear cutting line during the cutting operation of the diamond blade.

Deleted: the

Deleted: inner and outer

BRIEF DESCRIPTION OF THE DRAWINGS

The above objects and other advantages of the present invention will become more apparent by describing in detail preferred embodiments thereof with reference to the attached drawings in which:

Deleted:

FIG. 1 is a front view of one conventional diamond blade for a cutting saw machine in which diamond particles are randomly distributed in a rim type cutting tip thereof;

Deleted: use in

FIG. 2 is a front view of the other conventional diamond blade in which diamond particles are randomly distributed in a rim type cutting tip thereof and a plurality of depressed portions are disposed in both surfaces of the rim type cutting tip thereof;

Deleted: inner and outer

Deleted:

FIG. 3 is a partial cross-sectional view of the conventional diamond blade shown in FIG. 1 to illustrate state in which the rim type cutting tip thereof is operated;

FIG. 4 is a perspective view of a diamond blade for cutting saw machine according to one preferred embodiment of the present invention, which two diamond layers are longitudinally disposed respectively in both surfaces of non-diamond portion of the rim type cutting tip to form two microscopic linear cutting grooves in the workpieces during the cutting operation;

~~Deleted:~~ use in

~~Deleted:~~ inner and outer

~~Deleted:~~ crushable materials

FIG. 5 is a partial cross-sectional view of the diamond blade of the present invention taken along line AA of FIG. 4 to illustrate state which the rim type diamond cutting tip is operated;

FIG. 6 is a perspective view of a diamond blade for cutting saw machine according to the other embodiment of the present invention in which a plurality of diamond layers are longitudinally disposed respectively on bottom surfaces of depressed portions of non-diamond portion, and both surfaces of non-diamond portion and the depth of bottom surfaces of depressed portions of the non-diamond portion is a half of the entire thickness of the non-diamond portion;

~~Deleted:~~ use in

~~Deleted:~~ inner and outer

FIG. 7 is a partial cross-sectional view of the diamond blade of the present invention overlapping cross-sections taken along lines B-B and C-C of FIG. 6 to illustrate state which the rim type diamond cutting tip is operated;

FIG. 8 is a perspective view of the diamond blade of the present invention which the depth of bottom surfaces of depressed portions of the non-diamond portion is less than a half of the entire thickness of the non-diamond portion;

FIG. 9 is a partial perspective view of the diamond blade of the present invention shown in FIG. 8; and

FIG. 10 is a partial cross-sectional view of the diamond blade of the present invention overlapping cross-sections taken along lines EE and FF of FIG. 9 to illustrate state which the rim type cutting tip is operated.

Deleted: diamond

5 DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

In several embodiments of this invention described below with reference to the accompanying drawings, the invention is applied to cutting saw machine.

FIG.4 is a perspective view of a diamond blade for cutting saw machine according to one preferred embodiment of the present invention which two diamond layers are longitudinally disposed respectively in both surfaces of non-diamond portion of the rim type cutting tip to form two microscopic linear cutting grooves in the workpieces during the cutting operation.

As shown in the Figure 4, the diamond blade 31 for the cutting saw machine comprises a wheel body 32 connected with a shaft of an electric motor, and a rim type cutting tip 33 circumferentially fixed on the wheel body 32 for cutting or grinding workpiece.

Here, the rim type cutting tip 33 comprises two thin diamond layers 38 and 38' longitudinally disposed respectively on both surfaces thereof parallel with the rotation direction of the diamond blade 31, and a non-diamond portion 35 disposed between two diamond layers 38 and 38', as shown in Figures 4 and 5.

FIG.5 is a partial cross-sectional view of the diamond blade of the present invention taken along line AA of FIG. 4 to illustrate state which the rim type diamond cutting tip 33 is operated.

As shown in the Figure 5, the thin diamond layers 38 and 38' are composed of particles 39 made of abrasive materials such as diamond, metal powders composing of cobalt, nickel, bronze, copper, etc., or particles of resin or ceramic.

Deleted: Referring to FIG.4, there is illustrated diamond blade 31 having rim type cutting tip 33 according to one preferred embodiment of the present invention for use in apparatus for grinding or cutting crushable materials such as cutting saw machine. ¶

Diamond

Deleted: crushable materials fixedly disposed circumferentially on the wheel body 32

Deleted: Rim

Deleted: in

Deleted: inner and outer

Deleted: FIG.

Deleted: ¶
Thin

Deleted: and grinding material, particles of metals

Deleted: and particles of

Especially, particles 39 of diamond in thin diamond layers 38 and 38' are randomly distributed, or in a predetermined pattern or arrangement such a single or double layer figure with grid shaped spots to reduce a amount of distributed diamond particles.

The non-diamond portion 35 can be further composed of abrasive materials such as diamond, and metal powders such as cobalt, nickel, bronze, copper, etc., or resin or ceramic.

The thin diamond layers 38 and 38' function to prevent edge area of both surfaces of the rim type cutting tip 33 from defacing, and to form two microscopic linear cutting grooves 37' and 37" in the workpiece 37 during the cutting operation, as shown in FIG.5. Thus, a portion 40 of the workpiece 37 between two cutting grooves 37' and 37" can be easily crushed by small frictional and /or rotation impact force of the non-diamond portion 35 and thereby the non-diamond portion 35 of the rim type cutting tip 33 is able to produce cutting chips with a relatively large size during cutting operation. Here, those chips are easily discharged from a cutting slot 36 outside with reducing the friction with the rim type cutting tip 33, thereby the diamond blade increases cutting rate and prevent the crushed chips from dispersing in the air.

In this embodiment of the present invention, it is noted that the rim type cutting tip 33 can be substituted by another rim type cutting tip composed of three or four thin diamond layers longitudinally disposed therein parallel with the rotation direction of the diamond blade respectively to form three or four microscopic linear cutting grooves in the workpiece during the cutting operation, and non-diamond portions disposed between the three or four diamond layers, as shown in Figures 7 and 10.

The diamond layers are each other disposed at predetermined intervals perpendicular to the rotation direction of the diamond blade between the non-diamond portions of the rim type cutting tip.

In this case, a portion of workpiece between the microscopic linear cutting grooves can be easily crushed by a friction and rotation impact force smaller than that of the non-diamond

Deleted: Particles

Deleted: given

Deleted: the

Deleted: used

Deleted: Non-diamond

Deleted: is

Deleted: grinding

Deleted: metals

Deleted: and

Deleted: Thin

Deleted: upper surface

Deleted: crushable materials

Deleted: crushable materials

Deleted: friction

Deleted: power

Deleted:

Deleted:

Deleted: relative

Deleted: so that

Deleted: of blade

Deleted: to increase

Deleted: ability

Deleted: to

Deleted: it

Deleted: crushable materials

Deleted: with

Deleted: crushable materials

Deleted: power

portion 35 of the rim type cutting tip 33 having the two thin diamond layers 38 and 38' as shown in Figure 5.

Also, the density of the diamond particles 39 distributed in the diamond layers 38 and 38' of the rim type cutting tip 33 is relatively larger than that of the non-diamond portion 35 of the rim type cutting tip 33.

Deleted: in the non-diamond portion of rim type cutting tip

Deleted: can be distributed in the density lower than that of

FIG. 6 is a perspective view of a diamond blade for cutting saw machine according to the other embodiment of the present invention in which a plurality of diamond layers are longitudinally disposed respectively on bottom surfaces of depressed portions of non-diamond portion and both surfaces of the non-diamond portion and the depth of bottom surfaces of depressed portions of the non-diamond portion is a half of the entire thickness of the non-diamond portion; and FIG. 7 is a partial cross-sectional view of the diamond blade of the present invention overlapping cross-sections taken along lines BB and CC of FIG. 6 to illustrate state which the rim type diamond cutting tip is operated. As shown in Figures 6 and 7, the diamond blade 41 for cutting saw machine comprises a wheel body 42 connected with a shaft of an electric motor, and a rim type cutting tip 43 disposed fixedly on the circumference of the wheel body 42.

Deleted: ¶
Referring to FIG.

Deleted: there are illustrated diamond blade 41 according to the other preferred embodiment of the present invention for use in apparatus for cutting and drilling crushable materials such as cutting saw machine. ¶
Diamond

Here, the rim type cutting tip 43 comprises a non-diamond portion 45 having a plurality of depressed portions 44 disposed at predetermined intervals to cross each other in inner and outer surfaces of the non-diamond portion 45, a plurality of diamond layers 48, 48', and 48'' longitudinally disposed parallel with the rotation direction of the diamond blade 41 respectively on the bottom surfaces of the depressed portions 44 of the non-diamond portion 45, and both divided surfaces of the non-diamond portion 45 divided by the depressed portions 44.

Deleted: Rim

Deleted: has

Deleted:

Deleted:

Deleted:

Deleted: ¶
Rim type cutting tip 43 further includes

Bottom surfaces of the depressed portions 44 of the non-diamond portion 45 are positioned on the plane forming the center between both surfaces of the non-diamond portions 45 to let the diamond layers 48' disposed thereon to form one microscopic linear cutting groove 47' in the workpiece 47 during the cutting operation of the diamond blade 41, as shown in FIG. 7.

Deleted:

Deleted: inner and outer

Deleted: , as shown in FIG. 6

Deleted: inner and outer

Deleted: crushable materials

Thus, the diamond layers 48, 48', and 48" on the bottom surfaces of the depressed portions 44 of the non-diamond portion 45, and the inner and outer surfaces of the non-diamond portion 45 form the three microscopic linear cutting grooves 47', 47", 47"' in the workpiece 47 to let the protruded portions 50 and 50' of the workpiece 47 between the microscopic linear cutting grooves 47, 47', and 47" to be easily crushed by a small friction and rotation impact force of the non-diamond portion 45 during the cutting operation of the diamond blade 41, as shown in FIG.7.

Deleted: crushable materials

Deleted: crushable materials

Deleted: power

Also, the density of the diamond particles distributed in the diamond layers 48, 48' and 48" is relatively larger than that of the non-diamond portion 45 of the rim type cutting tip 33.

Deleted: in the non-diamond portion 45 of rim type cutting tip 43,

Deleted: can be distributed in the density lower than that of

Alternatively, in this embodiment of the present invention, the depth of bottom surfaces of the depressed portions 54 in the non-diamond portion 55 can be less than a half of the entire thickness of the non-diamond portion 55 to let the diamond layers 58' and 58" disposed thereon to form the two microscopic linear cutting grooves 57" and 57"' in the workpiece 57 during the cutting operation of the diamond blade 51, as shown in FIG.10.

Thus, in this case, the diamond layers 58, 58', 58", and 58"' on both surfaces of the non-diamond portion 55 and the bottom surfaces of depressed portions 54 thereof form four microscopic linear cutting grooves 57', 57", 57" and 57"' in the workpiece 57 to let protruded portions 60, 60' and 60" of the workpiece 57 between the cutting grooves 57', 57", 57" and 57"' to be easily crushed by a small friction and rotation impact force of the non-diamond portions 55 during the cutting operation of the diamond blade 51, as shown in FIG.10.

Deleted: crushable materials

Deleted: inner and outer

Deleted: crushable materials

Deleted: crushable materials

Deleted: power

Deleted: Operation

Deleted: use in

Deleted: Referring to

Deleted: , there is illustrated the operation of diamond blades 31 of one embodiment of the present invention which two thin diamond layers 38 and 38' are longitudinally disposed respectively in inner and outer surfaces of rim type cutting tip 33. At first,

The operation of the diamond blades having the rim type cutting tip for an apparatus such as a cutting saw machine according to the embodiments of the present invention will be described, hereinafter.

As shown in FIG. 4, when the wheel body 32 connected to the shaft of electric motor is rotated by the operation of the electric motor, the rim type cutting tip 33 begins to cut or grind

Deleted: an

Deleted: connected with a shaft thereof to

workpieces 37 such as brick, concrete, granite, marble, etc., and then a cutting slot 36 is generated in the workpiece 37 along a predetermined line.

At this time, since the thin diamond layers 38 and 38' including the particles 39 of diamond disposed in both surfaces of the rim type cutting tip 33, both the edges of the rim type cutting tip 33 are defaced less than the center of the diamond blade and thereby the two microscopic linear cutting grooves 37' and 37'' are formed in the cutting slot 36 in the workpiece 37, as shown in FIG. 5.

By forming the cutting grooves 37' and 37'', the protrude portion 40 of the workpiece 37 therebetween is weakened and easily crushed by a small friction and rotation impact force of the non-diamond portion 35. Thus, the non-diamond portion 35 of the rim type cutting tip 33 is able to produce cutting chips with relatively large size, and the produced chips are easily discharged from the cutting slots 36 outside with reducing the friction between the rim type cutting tip 33 and the workpiece, thereby the diamond blade 31 increases cutting rate and prevents the produced chips from dispersing in the air.

Therefore, by repeating the operation of the rim type cutting tip 33 of the diamond blade 31, the workpiece 37 along the predetermined line thereon is cut or ground.

Similarly, as shown in Figures 7 and 10, the operation of these diamond blades 41 and 51 is the same that of the diamond blade 31 of embodiment noted above expect that the diamond layers 48, 48', and 48'', or 58, 58', 58'', 58''', and 58'''' on both surfaces of the non-diamond portion 45 or 55 and bottom surfaces of depressed portions 44 or 54 form the three or four linear cutting grooves 47', 47'', and 47''', or 57', 57'', 57''', and 57'''' in the workpieces 47 or 57.

As apparent from the foregoing description, it can be appreciated that the present invention provides a diamond blade having a rim type cutting tip which at least two diamond layers are longitudinally disposed along the rotation direction of the diamond blade to form at

Deleted: crushable materials

Deleted: cutting tip 33 begins to grind crushable materials 37 to

Deleted: form

Deleted: therein

Deleted: thereon

Deleted: are

Deleted: inner and outer

Deleted: thereof

Deleted: of

Deleted: crushable materials

Deleted: crushable materials

Deleted: power

Deleted: relative

Deleted: with

Deleted: of

Deleted: blade 31,

Deleted: to increase

Deleted: ability

Deleted: to prevent

Deleted: In this way,

Deleted: cutting crushable materials

Deleted: completed.

Deleted: Referring to FIG.

Deleted: there are illustrated the operation of diamond blades 41 and 51 of the other embodiment of the present invention. ¶
The

Deleted: inner and outer

Deleted: crushable materials

least two microscopic linear cutting grooves in the workpieces during the cutting operation, and thereby they form the protrude portions of workpieces between the cutting grooves to be easily crushed by the non-diamond portions of the rim type cutting tip and enhance cutting rate of the diamond blade.

Deleted: crushable materials

Deleted: to cause

Deleted: crushable materials

Deleted: to

Deleted: ability

Also, the present invention provides a diamond blade having a structure which the rim type cutting tips are able to produce cutting chips with relatively large size during the cutting operation, so that those chips are easily discharged from the cutting slot outside with reducing the friction between the rim type cutting tip and the workpiece, thereby they increase cutting rate and prevent the crushed chips from dispersing in the air and from causing the bad affects to user's health and the contamination of environment.

Deleted: tip

Deleted: relative

Deleted: with

Deleted: of blade,

Deleted: to

Deleted: ability

Deleted: to

Deleted: it

Deleted: giving rise to

Deleted: effects

Deleted: given

Deleted: the

Deleted: used

Deleted: reduce

Also, the present invention provides a diamond blade having a rim type cutting tip which diamond particles in diamond layer thereof are distributed in a predetermined pattern to reduce a amount of distributed diamond particles and thereby reducing the manufacturing cost of the diamond blade.

upper surface

crushable

materials

to be cut

crushable materials

as shown in FIG.3

by

to

the blade 1, i.e., upper surface

upper surface

wall

formed in crushable materials 18 during cutting operation

thereof

of crushable materials 18

crushable materials

to be cut

crushable materials

be able to induce

decrease

ability

Page 2: [5] Deleted

8/2/2002 1:17 PM

size

Page 2: [5] Deleted

4/30/2002 10:42 AM

are easy to remain

Page 2: [5] Deleted

4/30/2002 10:42 AM

of crushable materials 18 to

Page 2: [5] Deleted

8/2/2002 1:18 PM

prevent

Page 2: [5] Deleted

4/30/2002 10:44 AM

decrease

Page 2: [5] Deleted

7/24/2002 5:40 PM

ability

Page 2: [5] Deleted

5/2/2002 4:17 PM

in case of

Page 2: [5] Deleted

5/2/2002 4:17 PM

gave rise to

Page 2: [5] Deleted

4/30/2002 10:45 AM

effects

that

are at given intervals

are still remained in problems to solve

for use in apparatus such as a cutting saw machine